ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES® International and Pan-An	Bannockbu	rn. Illinois. A	ll rights reserved un tions.	nder both This doc	ument is ts, the d	s a declaratio eclaration en	n of the sub compasses	ostances all lower	within the manufacture r level materials for wh	er listed	item. Note: if nanufacturer	the item is an as has engineering	ssembly with lowe responsibility.	
	.1 IPC Web Site for Information on IPC-1752 Standard Form 7 http://www.ipc.org/IPC-175x Distrib				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Inform					Ifg Informati	on			
Supplier Information														
Company name* Compa			Company unique ID			Unique ID Authority					Response Date*			
onsemi										2024-05-21				
Dentact Name Title - Contact			t J		Pho	Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Envir			Enviro Compliance		NA	NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represen			sentative J		Pho	Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product E			oduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		Mfr Item Name		Eff	ective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	NCL31010MNITWG Pol		PoE I/f Intelligent LED Driver - I2C version		on 202	24-05-21		E	BE4		153.01	mg	Each	
Manufacturing Proccess Information	1													
Terminal Plating / Grid Array Materia	Material Terminal Base A		Alloy J-STD-020 MSL Rating			Peak Process Body Temperatu		nperatur	ure Max Time at Peak Temper		ture Numb	er of Reflow Cyc	cles	
Matte Tin (Sn) - annealed CU Alloy		3	3		260		С	30	seco	nds 3				
omments														
TTENTION: MSL 3 Rated item requires Ba	ke and Dry	y Pack (after	electrical test)											
or more information regarding material com	position pl	lease refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in the sparaph.If the Company and the Supplier is substance of its substance of its substance of the applicable to such array rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the wa											
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measur
Die	6.69	mg	Supplier	Silicon (Si)	7440-21-3		6.69	mg
Die Attach	2.74	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.1644	mg
			Supplier	Silver (Ag)	7440-22-4		2.2331	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.1644	mg
			Supplier	Misc.	Proprietary Data		0.0137	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.1644	mg
Lead Frame 8	82.15	mg	Supplier	Zinc (Zn)	7440-66-6		0.0822	mg
			Supplier	Iron (Fe)	7439-89-6		1.8895	mg
			Supplier	Copper (Cu)	7440-50-8		80.0963	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0821	mg
Mold Compound-Black	56.04	mg	Supplier	Epoxy resins	129915-35-1		2.802	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.802	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2242	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		1.2889	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		47.634	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.2889	mg
Plating	3.32	mg	Supplier	Tin (Sn)	7440-31-5		3.32	mg
Wire Bond - Au	2.07	mg	Supplier	Gold (Au)	7440-57-5		2.07	mg